



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: MICHAEL KENNY ET AL.

FILED:

APPLICATION No.:

NOVEMBER 25, 2003

10/721,495

FOR: SINGLE WAFER CLEANING WITH OZONE

EXAMINER:

ART UNIT:

CONF. NO:

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

1. <u>Timing of Submission</u>

This supplemental IDS is believed to be timely in that it is being submitted under 37 CFR § 1.97(b), that is (1) within three months of the filing date of the application, which is not a continued prosecution application filed under § 1.53(d); or (2) within three months of entry of the national stage as set forth in 37 CFR § 1.491; or (3) before the mailing of a first Office action on the merits; or (4) before the mailing of a first Office action after filing a request for continued examination under § 1.114. Thus, no fee is required. The references listed on the enclosed Form PTO-1449 (modified) may be material to the examination of this application; the Examiner is requested to make them of record in the application.

2. <u>Cited References</u>

Copies of all cited references are enclosed.

Certificate of Mailing

I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage in an envelope addressed to Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

pale of Deposit

Debbie Gilbert

3. Effect of Information Disclosure Statement (37 C.F.R. § 1.97(h))

This Information Disclosure Statement is not to be construed as a representation that: (i) a search has been made; (ii) additional information material to the examination of this application does not exist; (iii) the information, protocols, results and the like reported by third parties are accurate or enabling; or (iv) the cited information is, or is considered to be, material to patentability. In addition, applicant does not admit that any enclosed item of information constitutes prior art to the subject invention and specifically reserves the right to demonstrate that any such reference is not prior art.

4. Fee Payment

No fees are believed due because this Information Disclosure Statement is being filed before the mailing of a first Office Action.

Dated: ˌ

_, 2004

Respectfully submitted,

PERKINS COIE LLP

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Phone: (310) 788-9900 Fax: (310) 788-3399 By: Kenneth H. Ohriner

Reg. No. 31,646

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	637		Y APPLICANT		Filing Date	November 25, 2003
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			-		U.S. PATENT DOCUMENTS			
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	DQ		Alder, M., et al., "The Kinetics and Mechanism of Hydroxide Ion Catalyzed Ozone Decomposition in Aqueous Solution." <i>J. Am. Chem. Soc.</i> , 72:1884-1886 (1950).					
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Form PTO-1449 (Modified) (Use several sheets if necessary)

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		OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS	
Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume issue number(s), publisher, city and/or country where published.	Т
	DX	Egitto, F.D., et al., "Removal of Poly (Dimethylsiloxane) Contamination From Silicon Surfaces With UV/Ozone Treatment." <i>Mat. Res. Soc. Symp. Proc.</i> , 385:245-250 (1995).	
	DY	Gabriel, C., et al., "Reduced Device Damage Using An Ozone Based Photoresist Removal Process." SPIE Advances in Resist Technology and Processing VI, 1086:598-604 (1989).	
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	EB	Goulding, M.R., "The selective epitaxial growth of silicon," <i>Materials Science and Engineering</i> , Vol. B17, pp. 47-67 (1993).	
	EC	Heyns, M.M., et al., "New Wet Cleaning Strategies for Obtaining Highly Reliable Thin Oxides." MRP Symposium Proceedings on Materials Research Society, Spring Meeting, San Francisco, CA, Apr. 12-13, p. 35 (1993).	
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		OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS	
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	EI	Krusell, W.C., et al., "Cleaning Technologies for High Volume Production of Silicon Wafers." ECS Proc. of the First Int'l. Symposium on Cleaning Technology in Semiconductor Device Mfg., pp. 23-32 (Oct. 1989).	
	EJ	Krusell, W.C., et al., "The Characterization of Silicon Substrate Cleaning Treatments by use of SIMS and MOS Electrical Testing." ECS Extended Abstracts, No. 229, p. 331-332 (1986).	
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	EL	Ohmi, T., et al., "Native Oxide Growth and Organic Impurity Removal on Si Surface with Ozone-Injected Ultrapure Water." <i>J. Electrochem. Soc.</i> , 140(3):804-810 (Mar. 1993).	
	EM	Sehested, K., et al., "Decomposition of Ozone in Aqueous Acetic Acid Solutions (pH 0-4)." J. Phys. Chem., pp. 1005-1009 (1992).	
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	EP	Tabe, M., "UV ozone cleaning of silicon substrates in silicon molecular beam epitaxy." <i>Appl. Phys. Lett.</i> , 45(10):1073-1075 (Nov. 1984).	
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	EU	Vig, J., et al., "UV/Ozone Cleaning of Surfaces." IEEE Transactions on Parts, Hybrids, and Packaging, Vol. PHP-12(4):365-370 (Dec. 1976).	
	EV	Vig, J., "UV/Ozone Cleaning of Surfaces." <i>U.S. Army Electronics Technology and Devices Laboratory</i> , ERADCOM, Ft. Monmouth, NJ, 07703-5302, pp. 1027-1034 (Sep./Oct. 1984).	
	EW	Zafonte, L., et al., "UV/Ozone Cleaning For Organics Removal on Silicon Wafers." SPIE Optical Microlithography III: Technology for the Next Decade, 470:164-175 (1984).	
	EX	Zazzera, L.A., et al., "XPS and SIMS Study of Anhydrous HF and UV/Ozone-Modified Silicon (100) Surfaces." <i>J. Electrochem. Soc.</i> , 136(2):484-491 (Feb. 1989).	
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